



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:** David J. Corisis

**Serial No.:** 09/918,739

**Filed:** July 31, 2001

**For:** METHODS FOR LEADS UNDER  
CHIP IN CONVENTIONAL IC PACKAGE

**Confirmation No.:** 3239

**Examiner:** D. Graybill

**Group Art Unit:** 2827

**Attorney Docket No.:** 2269-2811.5US  
(96-0243.05/US)

**Notice of Allowance Mailed:**

March 30, 2004

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

June 28, 2004  
Date

Signature

Deidra J. Pfeil  
Name (Type/Print)

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Amendments to the Specification** appear on page 2 of this paper.

**A Listing of the Claims** begins on page 3 of this paper.

**Amendments to the Drawings** appear on page 6 of this paper and include both attached replacement sheet and annotated sheet showing changes.

**Remarks** begin on page 7 of this paper.